

#### **BOARD-TO-BOARD HEADERS & RECEPTACLES**



✓ Active

#### TE CONNECTIVITY (TE)

## .6FHR04H,140,S,GIG,08/Sn,HT,SEYes

0.6mm FH | .6mm FH

1-5316560-0

TE Internal Number: 1-5316560-0

# **EU RoHS Compliant**

**EU ELV Compliant** 

**Connector Style** Receptacle

Connector System Board-to-Board

**Number of Positions** 140

Centerline (Pitch) .6 mm [ .024 in ]

Stack Height 4 mm [.157 in]



### **PRODUCT DRAWING**

Japanese



**→** 3D PDF

#### **DOCUMENTATION**

**Product Drawings** 

## HARD TRAY ASSY FH 0.6BTB CONNECTOR REC 4H W/G-CONT

PDF (TIFF AVAILABLE)

**Japanese** 

**CAD Files** 

#### **Customer View Model**

2D\_DXF.ZIP

**English** 

### **Customer View Model**

3D\_IGS.ZIP

**English** 

| English  |   |
|--|---|
| 3D PDF   |   |
| PDF  |   |
| English  |   |
| Product Specifications   |   |
| Application Specification  |   |
| AMP FH 0.6mm Pitch Board-To-Board Connector  |   |
| TIF  |   |
| English Control of the Control of th |   |
| AMP FH 0.6mm Pitch Board-To-Board Connector  PDF   |   |
| English  |   |
|  |   |
| <b>FEATURES</b>  | + |
|  |   |
|  |   |
| Please review product documents or contact us for the latest agency approval information.  |   |
| Please Note: Use the Product Drawing for all design activity.  |   |
| Product Type Features  |   |
| Connector Style Receptacle   |   |
| Connector System Board-to-Board  |   |
| Connector & Contact Terminates To Printed Circuit Board  Series Free Height  |   |
| PCB Mounting Orientation Vertical  |   |
| Boss With  |   |
| Product Type Connector   |   |
| Configuration Features   |   |
| Stackable Yes  |   |
| Number of Positions 140  |   |
| Board-to-Board Configuration Mezzanine  Number of Rows 2   |   |
| Preloaded Yes  |   |
| Electrical Characteristics   |   |
| Dielectric Withstanding Voltage (VAC) 200  |   |
| Voltage (VAC) 50   |   |
| Body Features  |   |
| Sealant With   |   |
|  |   |
| Contact Features   |   |
|  |   |
|  |   |

**Customer View Model** 

3D\_STP.ZIP

**Solder Tail Contact Plating Material** Gold, Tin **Grounding Contact** With Contact Plating Material Gold Flash, Nickel, Tin Contact Plating Thickness 0.05–0.127, 1, 1.3 **Contact Mating Area Plating Material** Gold Contact Mating Area Plating Thickness .2 µm [7.874 µin] Contact Current Rating (Max) (A) .5 Solder Tail Contact Plating Thickness (µm) .05, 1 Solder Tail Contact Plating Thickness (µin) 1.9685, 39.37 **Contact Base Material** Copper Alloy **Contact Type** Socket **Contact Layout Inline Termination Features Termination Method to PC Board** Surface Mount Mechanical Attachment **Mating Alignment** With Mating Alignment Type Polarization **PCB Mount Retention** With **PCB Mount Retention Type** Solder Peg **PCB Mount Alignment** With **PCB Mount Alignment Type** Locating Posts **Housing Features** Centerline (Pitch) .6 mm [ .024 in ] **Housing Material** High Temperature Thermoplastic **Dimensions** Stack Height 4 mm [.157 in] Height 4 mm [.157 in] **Usage Conditions Operating Temperature Range (°C)** -40 – 85 Operation/Application Pick and Place Cover Without For Use With Plug **Industry Standards UL Flammability Rating** UL 94V-0 **Packaging Features** 

PRODUCT COMPLIANCE

**Packaging Method** Hard Tray

Packaging Quantity 30

Statement of Compliance

## **Statement of Compliance**

PDF